onsemi

ECOSPARK[®]2 320 mJ, 450 V, N-Channel Ignition IGBT

FGD3245G2-F085, FGB3245G2-F085

General Description

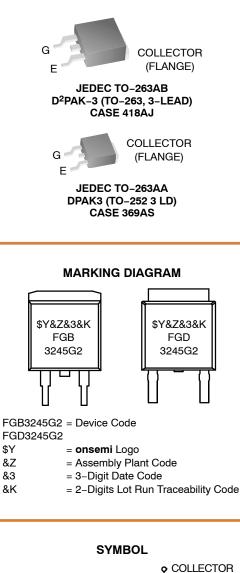
The FGB3245G2–F085 and FGD3245G2 are N-channel IGBTs designed in **onsemi**'s ECOSPARK-2 technology which helps in eliminating external protection circuitry. The technology is optimized for driving the coil in the harsh environment of automotive ignition systems and offers out–standing Vsat and SCIS Energy capability also at elevated operating temperatures. The logic level gate input is ESD protected and features an integrated gate resistor. An integrated zener–circuitry clamps the IGBT's collecter–to–emitter voltage at 450 V which enables systems requiring a higher spark voltage

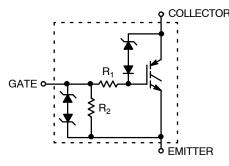
Features

- SCIS Energy = 320 mJ at $T_J = 25^{\circ}C$
- Logic Level Gate Drive
- Low Saturation Voltage
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Automotive Ignition Coil Driver Circuits
- Coil On Plug Applications





ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

Symbol	Parameter	Rating	Unit
BV _{CER}	Collector to Emitter Breakdown Voltage (I _C = 1 mA)	450	V
BV _{ECS}	Emitter to Collector Voltage – Reverse Battery Condition (I _C = 10 mA)	28	V
E _{SCIS25}	Self Clamping Inductive Switching Energy (Note 1)	320	mJ
E _{SCIS150}	Self Clamping Inductive Switching Energy (Note 2)	180	mJ
I _{C25}	Collector Current Continuous, at V_{GE} = 5 V, T_C = 25°C	41	А
I _{C110}	Collector Current Continuous, at V_{GE} = 5 V, T_C = 110°C	27	А
V_{GEM}	Gate to Emitter Voltage Continuous	±10	V
P _D	Power Dissipation Total, at $T_C = 25^{\circ}C$	150	W
	Power Dissipation Derating, for $T_C > 25^{\circ}C$	1.1	W/°C
TJ	Operating Junction Temperature Range	-40 to +175	°C
T _{STG}	Storage Junction Temperature Range	-40 to +175	°C
ΤL	Max. Lead Temp. for Soldering (Leads at 1.6 mm from case for 10 s)	300	°C
T _{PKG}	Max. Lead Temp. for Soldering (Package Body for 10 s)	260	°C
ESD	Electrostatic Discharge Voltage at 100 pF, 1500 Ω	4	kV
	CDM-Electrostatic Discharge Voltage at 1 Ω	2	kV

DEVICE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality

should not be assumed, damage may occur and reliability may be affected. 1. Self Clamping Inductive Switching Energy (E_{SCIS25}) of 320 mJ is based on the test conditions that starting Tj = 25°C; L = 3 mHy, I_{SCIS} = 14.6 A, V_{CC} = 100 V during inductor charging and V_{CC} = 0 V during the time in clamp. 2. Self Clamping Inductive Switching Energy ($E_{SCIS150}$) of 180 mJ is based on the test conditions that starting Tj = 150°C; L = 3 mHy, I_{SCIS} = 10.9 A, V_{CC} = 100 V during inductor charging and V_{CC} = 0 V during the time in clamp.

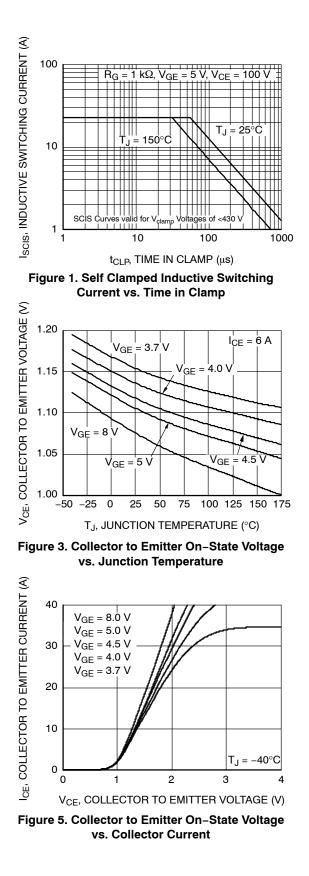
Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
OFF STAT	E CHARACTERISTICS						
BV _{CER}	Collector to Emitter Breakdown Voltage	I_{CE} = 2 mA, V_{GE} = 0, R_{GE} = 1 k Ω , T_J = -40 to 150°C		420	-	480	V
BV _{CES}	Collector to Emitter Breakdown Voltage	I_{CE} = 10 mA, V_{GE} = 0 V, R_{GE} = 0, T_{J} = –40 to 150 $^{\circ}C$		440	-	500	V
BV _{ECS}	Emitter to Collector Breakdown Voltage	I_{CE} = -75 mA, V_{GE} = 0 V, T_{J} = 25°C		28	-	-	V
BV_{GES}	Gate to Emitter Breakdown Voltage	$I_{GES} = \pm 2 \text{ mA}$		±12	±14	-	V
I _{CER}	Collector to Emitter Leakage Current	V_{CE} = 250 V, R_{GE} = 1 k Ω	$T_J = 25^{\circ}C$	-	-	25	μA
			T _J = 150°C	-	-	1	mA
I _{ECS}	Emitter to Collector Leakage Current	V _{EC} = 24 V	$T_J = 25^{\circ}C$	-	-	1	mA
			T _J = 150°C	-	-	40	
R ₁	Series Gate Resistance			-	120	-	Ω
R ₂	Gate to Emitter Resistance			10 k	-	30 k	Ω
ON STATE	CHARACTERISTICS	•					
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	$I_{CE} = 6 \text{ A}, V_{GE} = 4 \text{ V}$	$T_J = 25^{\circ}C$	-	1.13	1.25	V
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	I _{CE} = 10 A, V _{GE} = 4.5 V	T _J = 150°C	-	1.32	1.50	V
V _{CE(SAT)}	Collector to Emitter Saturation Voltage	I _{CE} = 15 A, V _{GE} = 4.5 V	T _J = 150°C	-	1.64	1.85	V
OYNAMIC	CHARACTERISTICS	•					
Q _{G(ON)}	Gate Charge	I_{CE} = 10 A, V_{CE} = 12 V, V_{GE} = 5 V		-	23	-	nC
V _{GE(TH)}	Gate to Emitter Threshold Voltage	I_{CE} = 1 mA, V_{CE} = V_{GE}	$T_J = 25^{\circ}C$	1.3	1.6	2.2	V
			T _J = 150°C	0.75	1.1	1.8	
V_{GEP}	Gate to Emitter Plateau Voltage	V _{CE} = 12 V, I _{CE} = 10 A		-	2.7	-	V
SWITCHIN	G CHARACTERISTICS						
t _{d(ON)R}	Current Turn-On Delay Time-Resistive	$V_{CE} = 14 \text{ V}, \text{ R}_{L} = 1 \text{ k}\Omega$		-	0.9	4	μs
t _{rR}	Current Rise Time-Resistive	- V _{GE} = 5 V, R _G = 1 kΩ, T _J = 25°C		-	2.6	7	μs
t _{d(OFF)L}	Current Turn-Off Delay Time-Inductive	$V_{CE} = 300 \text{ V}, \text{ L} = 1 \text{ mH},$ $V_{GE} = 5 \text{ V}, \text{ R}_{G} = 1 \text{ k}\Omega,$ $I_{CE} = 6.5 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C}$		-	5.4	15	μs
t _{fL}	Current Fall Time-Inductive			-	2.7	15	μs
E _{SCIS}	Self Clamped Inductive Switching	L = 3.0 mHy, RG = 1 kΩ, VGE = 5 V, (Note 3)	TJ = 25°C	-	-	320	mJ
THERMAL	CHARACTERISTICS	1					
$R_{\theta JC}$	Thermal Resistance Junction to Case	All packages		_	_	0.9	°C/W
						1	

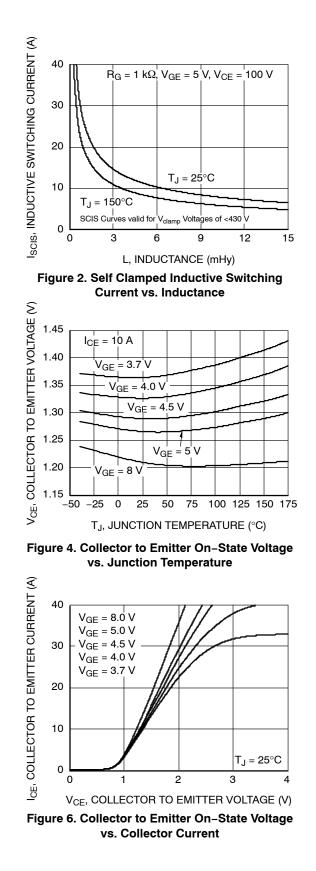
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

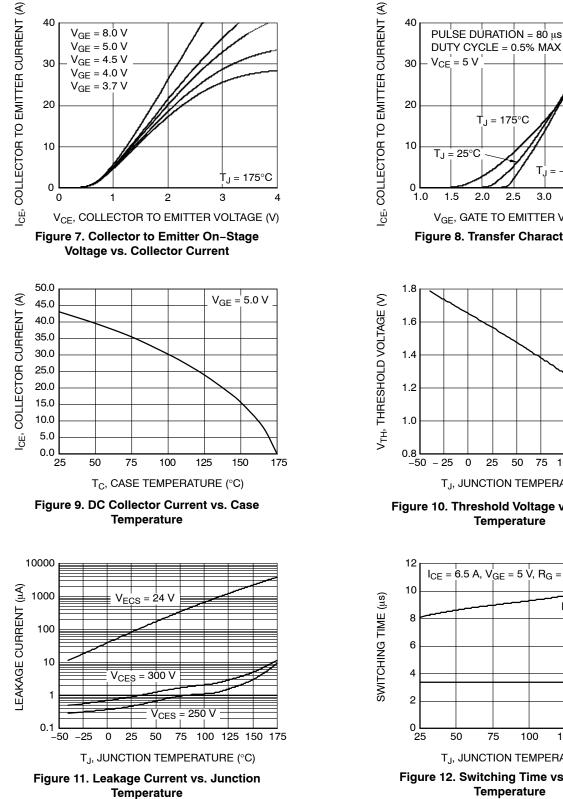
performance may not be indicated by the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Self Clamping Inductive Switching Energy (E_{SCIS25}) of 320 mJ is based on the test conditions that starting Tj = 25°C; L = 3 mHy, I_{SCIS} = 14.6 A, V_{CC} = 100 V during inductor charging and V_{CC} = 0 V during the time in clamp.

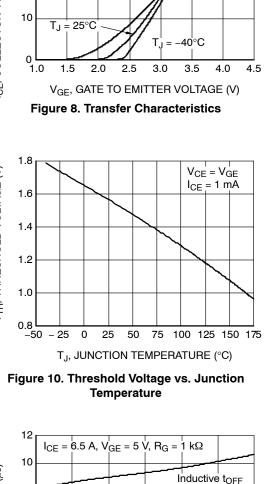
TYPICAL PERFORMANCE CURVES

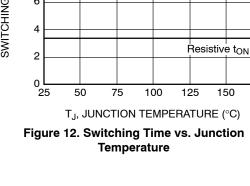




TYPICAL PERFORMANCE CURVES (Continued)







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TYPICAL PERFORMANCE CURVES (Continued)

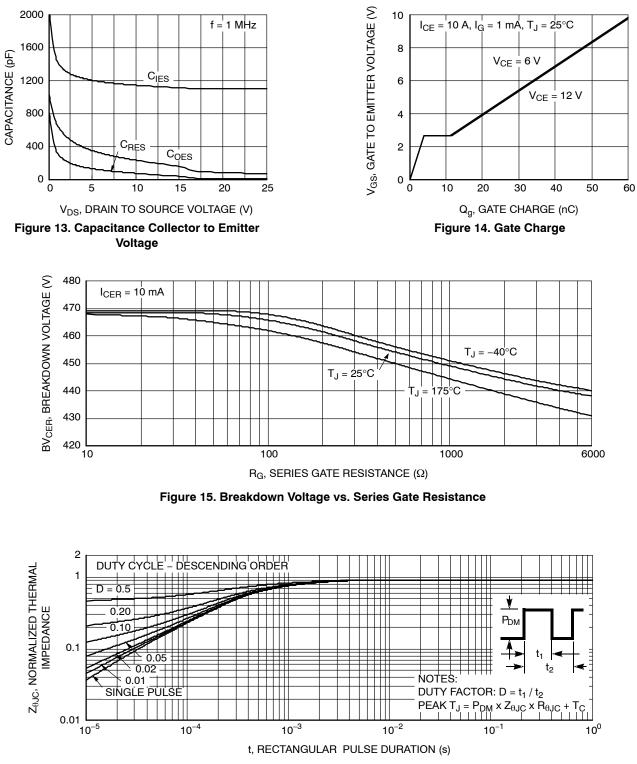
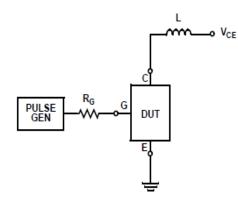


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction to Case

TESTE CIRCUITS AND WAVEFORMS



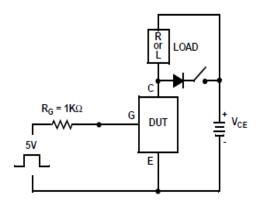


Figure 17. Inductive Switching Test Circuit



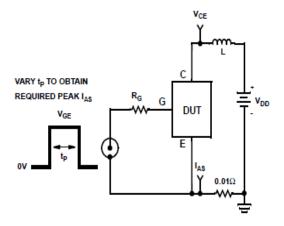


Figure 19. Energy Test Circuit

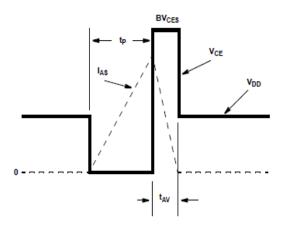


Figure 20. Energy Waveforms

PACKAGE MARKING AND ORDERING INFORMATION

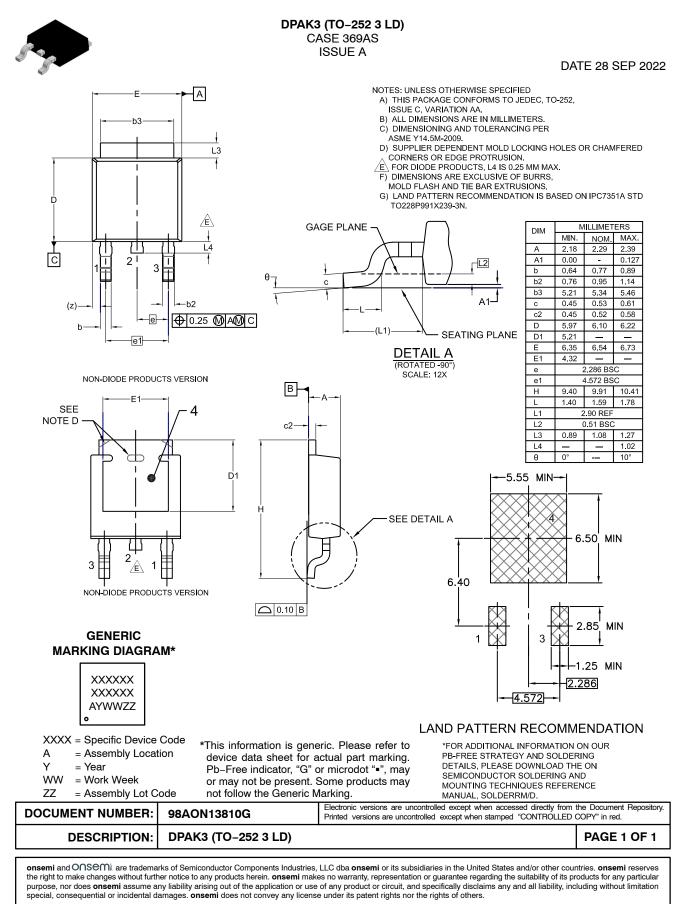
Device Marking	Device	Package	Reel Size	Tape Width	Shipping [†]
FGD3245G2	FGD3245G2-F085	DPAK3 (TO-252 3 LD) TO252AA (Pb-Free)	330 mm	16 mm	2500 / Tape & Reel
FGB3245G2	FGB3245G2-F085	D ² PAK-3 (TO-263, 3-LEAD) TO263AB (Pb-Free)	330 mm	24 mm	800 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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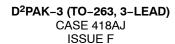
MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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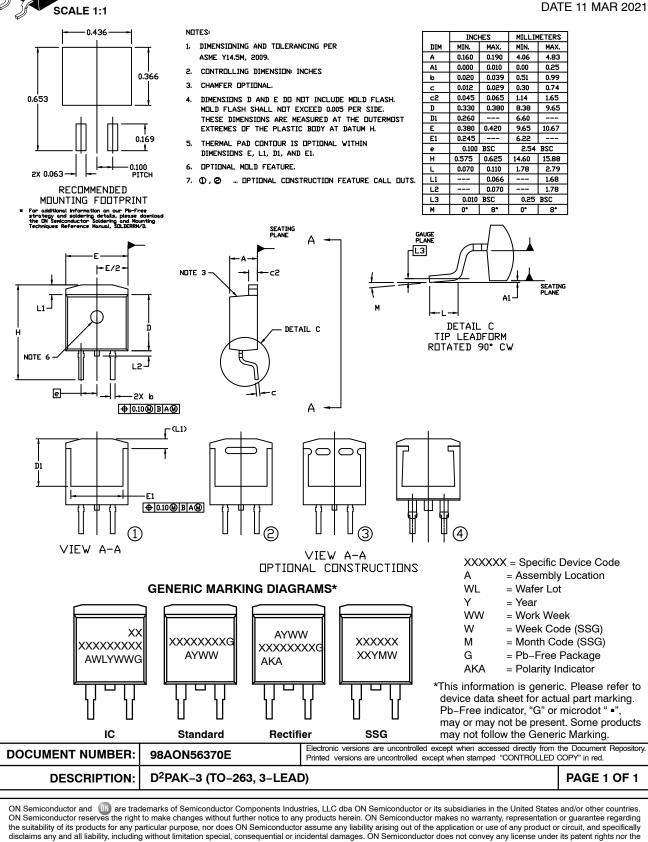


MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS









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